

SK75GAR12T4



SEMITOP® 2

IGBT Module

SK75GAL12T4

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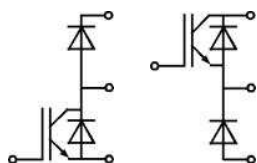
Features

- One screw mounting module
- Trench4 IGBT technology
- CAL4 technology FWD

Typical Applications*

Remarks

- $V_{CE,sat}$, V_F = chip level value



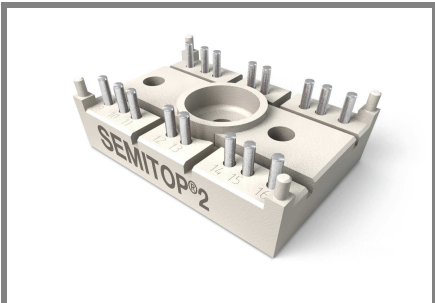
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Absolute Maximum Ratings				$T_s = 25\text{ °C}$, unless otherwise specified	
Symbol	Conditions			Values	Units
IGBT					
V_{CES}	$T_j = 25\text{ °C}$			1200	V
I_C	$T_j = 175\text{ °C}$	$T_s = 25\text{ °C}$		80	A
		$T_s = 70\text{ °C}$		65	A
I_{CRM}	$I_{CRM} = 3 \times I_{Cnom}$			225	A
V_{GES}				± 20	V
t_{psc}	$V_{CC} = 800\text{ V}$; $V_{GE} \leq 15\text{ V}$; $T_j = 150\text{ °C}$ $V_{CES} < 1200\text{ V}$			10	μs
Inverse Diode					
I_F	$T_j = 175\text{ °C}$	$T_s = 25\text{ °C}$		20	A
		$T_s = 70\text{ °C}$		16	A
I_{FRM}	$I_{FRM} = 3 \times I_{Fnom}$			45	A
I_{FSM}	$t_p = 10\text{ ms}$; half sine wave $T_j = 150\text{ °C}$			90	A
Freewheeling Diode					
I_F	$T_j = 175\text{ °C}$	$T_s = 25\text{ °C}$		70	A
		$T_s = 70\text{ °C}$		55	A
I_{FRM}	$I_{FRM} = 3 \times I_{Fnom}$			225	A
I_{FSM}	$t_p = 10\text{ ms}$; half sine wave $T_j = 150\text{ °C}$			425	A
Module					
$I_{t(RMS)}$					A
T_{vj}				-40 ... +175	$^{\circ}\text{C}$
T_{stg}				-40 ... +125	$^{\circ}\text{C}$
V_{isol}	AC, 1 min.			2500	V

Characteristics			T _s = 25 °C, unless otherwise specified					
Symbol	Conditions		min.	typ.	max.	Units		
IGBT								
V _{GE(th)}	V _{GE} = V _{CE} , I _C = 3 mA		5	5,8	6,5	V		
I _{CES}	V _{GE} = 0 V, V _{CE} = V _{CES}	T _j = 25 °C				1,0	mA	
		T _j = 150 °C				mA		
I _{GES}	V _{CE} = 0 V, V _{GE} = 20 V	T _j = 25 °C				600	nA	
		T _j = 150 °C				nA		
V _{CE0}		T _j = 25 °C				1,1	1,3	V
		T _j = 150 °C				1	1,2	V
r _{CE}	V _{GE} = 15 V	T _j = 25°C				10		mΩ
		T _j = 150°C				16		mΩ
V _{CE(sat)}	I _{Cnom} = 75 A, V _{GE} = 15 V	T _j = 25°C _{chiplev.}				1,85	2,05	V
		T _j = 150°C _{chiplev.}				2,25	2,45	V
C _{ies}	V _{CE} = 25, V _{GE} = 0 V f = 1 MHz					4,4		nF
C _{oes}						0,29		nF
C _{res}						0,235		nF
Q _G	V _{GE} =-7V...+15V					570		nC
R _{Gint}	T _j = 25 °C					10		Ω
t _{d(on)}	R _{Gon} = 15 Ω di/dt = 2000 A/μs	V _{CC} = 600V I _C = 75A T _j = 150 °C V _{GE} = -7/+15V				50		ns
t _r						60		ns
E _{on}						13		mJ
t _{d(off)}	R _{Goff} = 15 Ω					500		ns
t _f						60		ns
E _{off}						7		mJ
R _{th(i-s)}	per IGBT					0,74		K/W

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Features

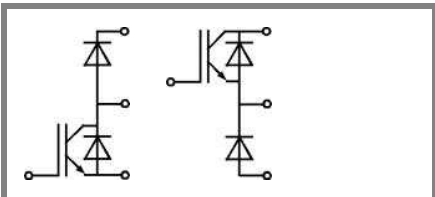
- One screw mounting module
- Trench4 IGBT technology
- CAL4 technology FWD

Typical Applications*

Remarks

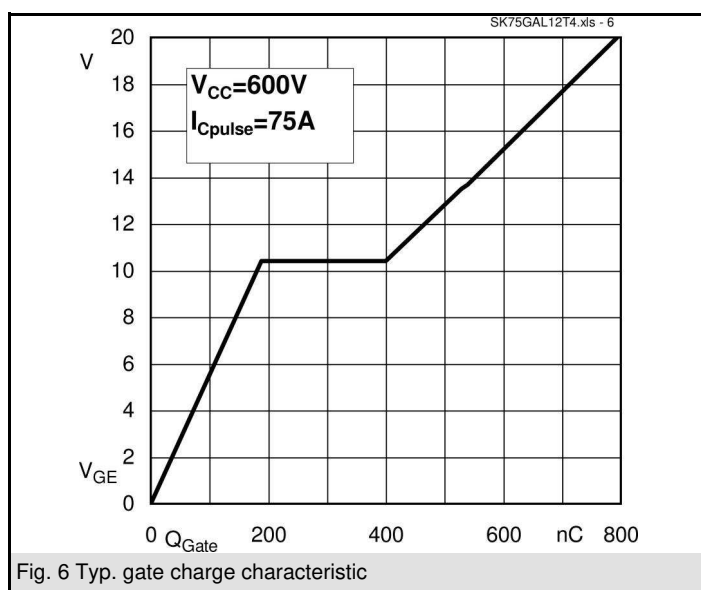
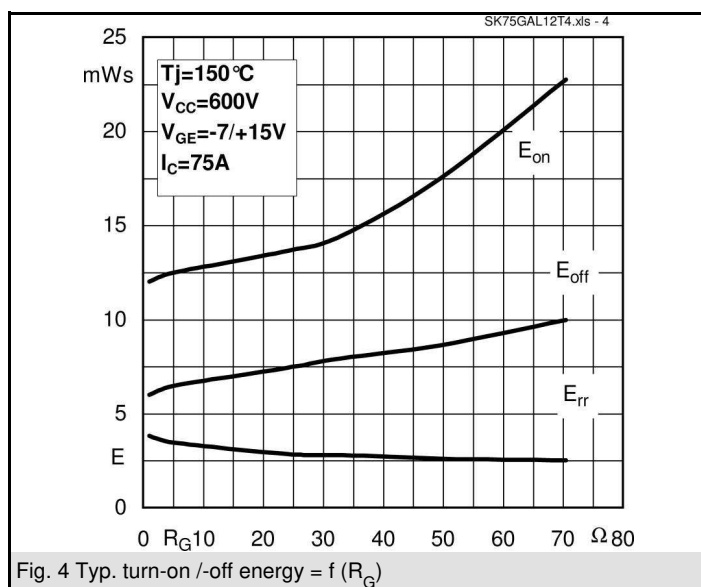
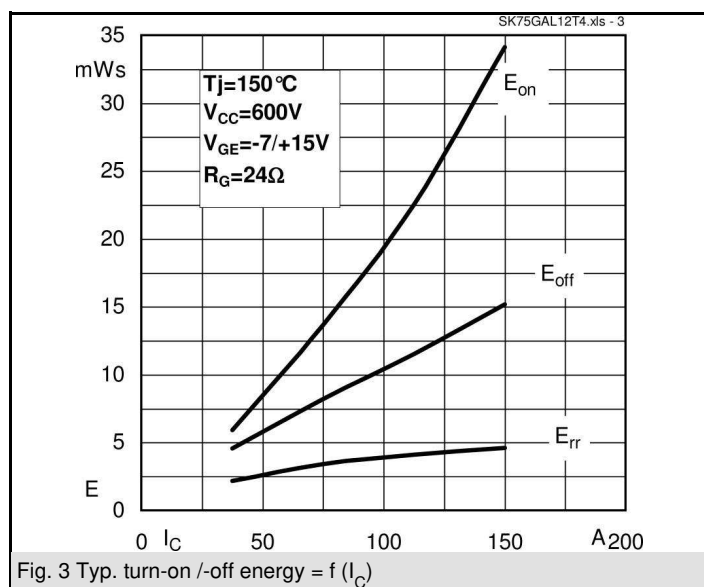
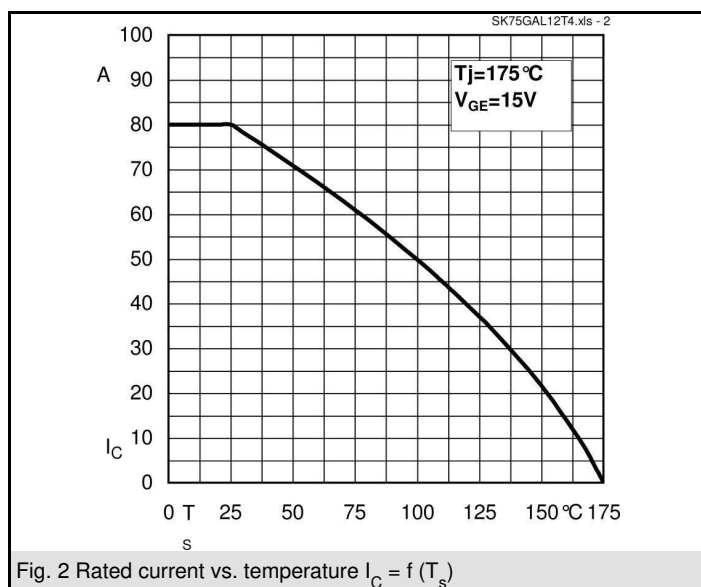
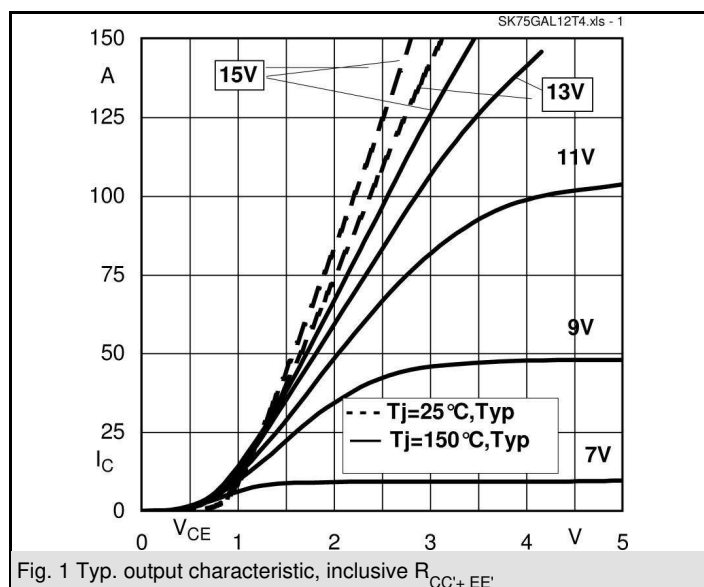
- $V_{CE,sat}$, V_F = chip level value

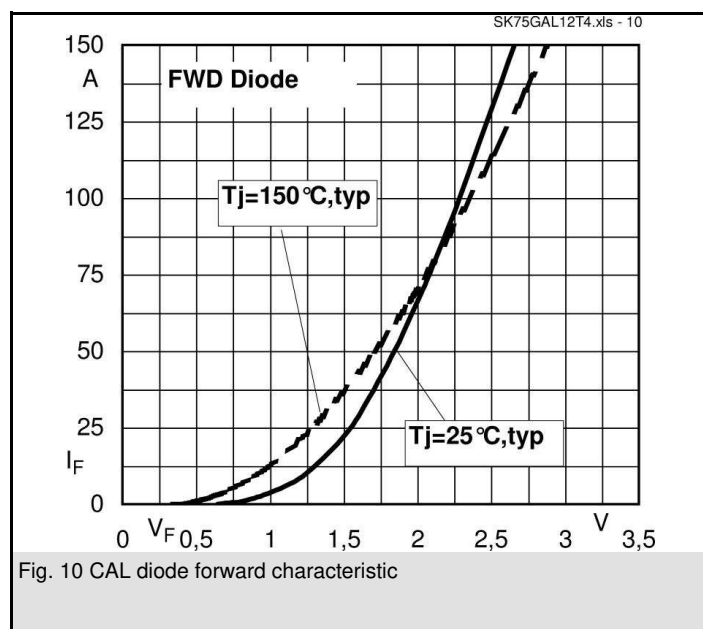
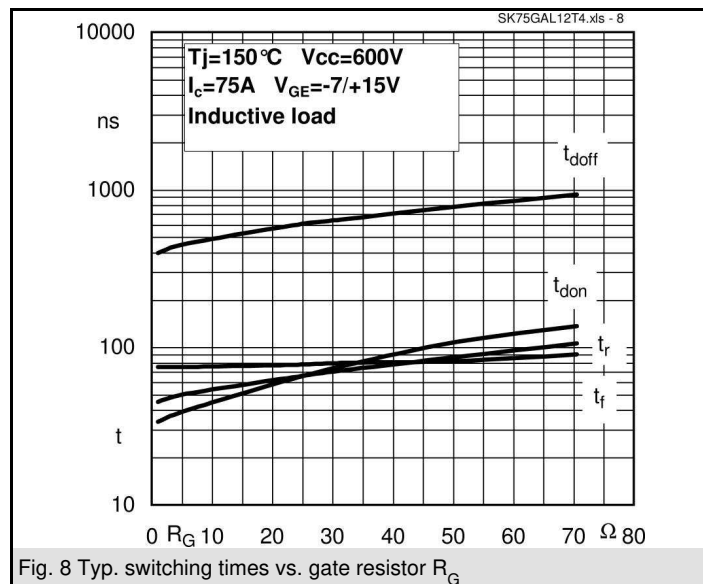
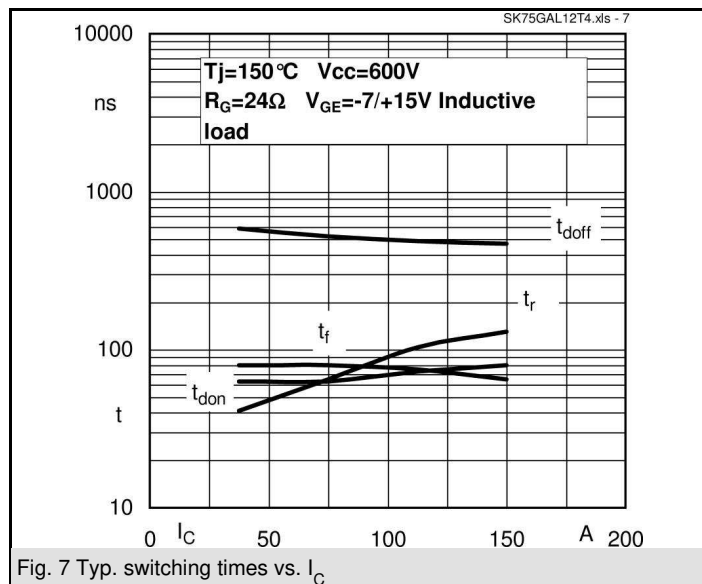
Characteristics		min.	typ.	max.	Units
Symbol	Conditions				
Inverse Diode					
$V_F = V_{EC}$	$I_{Fnom} = 15\text{ A}; V_{GE} = 0\text{ V}$	$T_j = 25\text{ °C}_{chiplev.}$	2,38	2,71	V
		$T_j = 150\text{ °C}_{chiplev.}$	2,44	2,77	V
V_{F0}		$T_j = 25\text{ °C}$	1,3	1,5	V
		$T_j = 150\text{ °C}$	0,9	1,1	V
r_F		$T_j = 25\text{ °C}$	72	80,7	mΩ
		$T_j = 150\text{ °C}$	102,8	111,6	mΩ
I_{RRM}	$I_F = A$	$T_j = 150\text{ °C}$			A
Q_{rr}					μC
E_{rr}	$V_{CC} = 600\text{ V}$				mJ
$R_{th(j-s)D}$	per diode		2,34		K/W
Freewheeling Diode					
$V_F = V_{EC}$	$I_{Fnom} = 75\text{ A}; V_{GE} = 0\text{ V}$	$T_j = 25\text{ °C}_{chiplev.}$	2,1	2,5	V
		$T_j = 150\text{ °C}_{chiplev.}$	2,4	2,5	V
V_{F0}		$T_j = 25\text{ °C}$	1,3	1,5	V
		$T_j = 150\text{ °C}$	0,9	1,1	V
r_F		$T_j = 25\text{ °C}$	12	13,3	V
		$T_j = 150\text{ °C}$	16	17,3	V
I_{RRM}	$I_F = 75\text{ A}$	$T_j = 150\text{ °C}$	45		A
Q_{rr}	$di/dt = 2000\text{ A/μs}$		10		μC
E_{rr}	$V_{CC} = 600\text{ V}$		3		mJ
$R_{th(j-s)FD}$	per diode		0,97		K/W
M_s	to heat sink			2,5	Nm
w			30		g
Temperature sensor					
R_{100}	$T_s = 100\text{ °C}$ ($R_{25} = 5\text{ kΩ}$)		493±5%		Ω

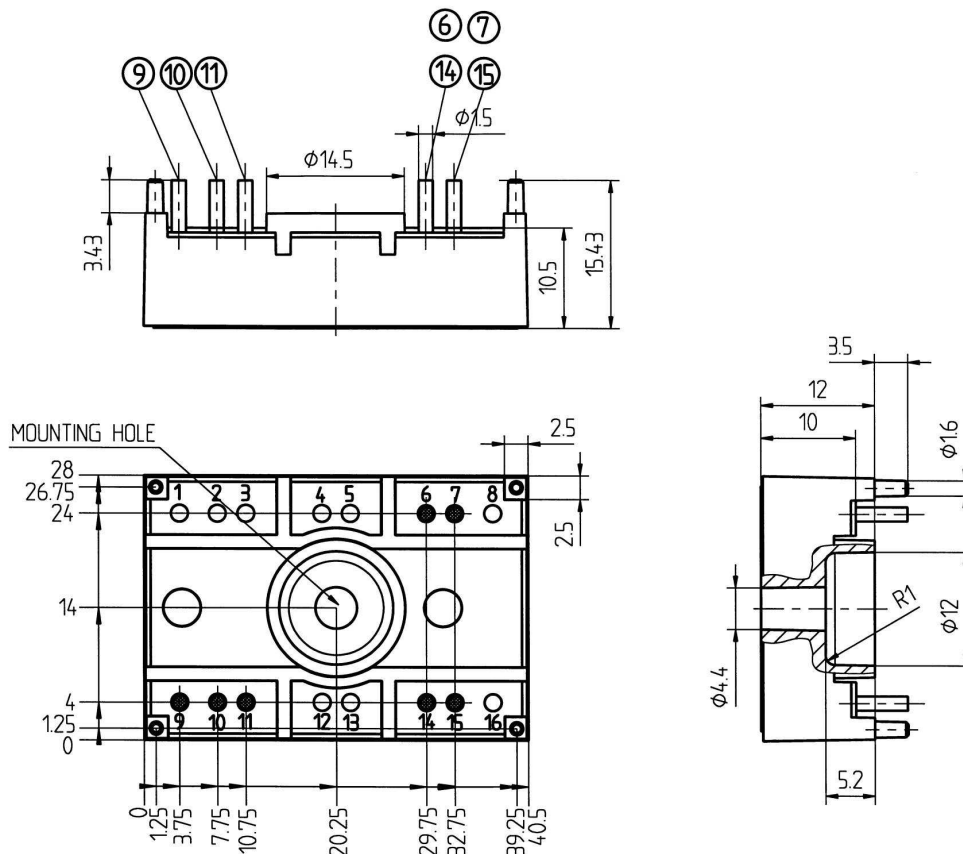


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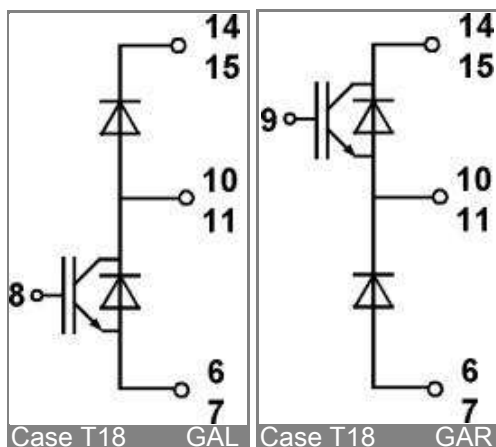
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Case T18 (Suggested hole diameter for the solder pins and mounting plastic pins: 2mm)



This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, chapter IX.

*IMPORTANT INFORMATION AND WARNINGS

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